


**ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	ADAPTIVE-ALLOCATION OF I/O BANDWIDTH USING A CONFIGURABLE INTERCONNECT TOPOLOGY						
<div>Application Number : 10/766334 </div> <div>Confirmation Number: 3273</div> <div>First Named Applicant: Michael Ching</div> <div>Attorney Docket Number: RAMB-01050US0</div> <div>Art Unit: 2661</div> <div>Examiner: Brian D Nguyen</div> <div>Search string: ( 20030065845 or 20030221061 ).pn</div>							
<p><u>Certification:</u> This Information Disclosure Statement was submitted under the following conditions, which satisfies the requirement under 37 CFR 1.97(e). The filer certified:</p> <p>That each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.</p>							
<b>US Published Applications</b>							
<b>Note: Applicant is not required to submit a paper copy of cited US Published Applications</b>							
init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
BN	1	20030065845	2003-04-03	Riley			
BN	2	20030221061	2003-11-27	El-Batal et al.			
<b>Signature</b>							
Examiner Name				Date			
/Brian Nguyen/				07/31/2006			